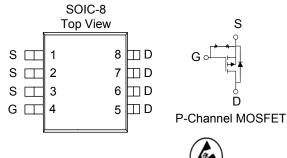
## P-Channel 30-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low  $r_{DS(on)}$  and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low r<sub>DS(on)</sub> provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe SOIC-8 saves board space
- Fast switching speed
- High performance trench technology

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$r_{\mathrm{DS(on)}} \mathrm{m}(\Omega) \qquad \qquad \mathrm{I_D(A)}$				
-30	$13 @ V_{GS} = -10V$	-11.5			
-30	$19 @ V_{GS} = -4.5V$	-9.3			



ESD Protected 3000 V

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C UNLESS OTHERWISE NOTED)							
Paramete r	Symbol	Maximum	Units				
Drain-Source Voltage		$ m V_{DS}$	-30	V			
Gate-Source Voltage	$V_{GS}$	±25	V				
Continuous Drain Current <sup>a</sup>	$T_A=25^{\circ}C$	I.	-11.5				
Continuous Drain Current	$T_{A}=25^{\circ}C$ $T_{A}=70^{\circ}C$	П	-9.3	A			
Pulsed Drain Current <sup>b</sup>	$I_{DM}$	±50					
Continuous Source Current (Diode Conduction) <sup>a</sup>	$I_S$	-2.1	A				
D	$T_A=25^{\circ}C$	D_	3.1	W			
Power Dissipation <sup>a</sup>	$T_{A}=25^{\circ}C$ $T_{A}=70^{\circ}C$	Гр	2.3	VV			
Operating Junction and Storage Temperature Range	$T_{J}, T_{stg}$	-55 to 150	°C				

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Maximum	Units			
Maximum Junction-to-Case <sup>a</sup>	t <= 5 sec	$R_{ heta JC}$	25	°C/W		
Maximum Junction-to-Ambient <sup>a</sup>	t <= 5 sec	$R_{\theta JA}$	50	°C/W		

1

## Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

SPECIFICATIONS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)							
Parameter			Limits			Unit	
Pararreter	Symbol	Test Conditions	Min	Тур	Max	Orac	
Static							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \text{ uA}$	-30			\ \	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{CS}$ , $I_D = -250 \text{ uA}$	-1			\ \ \	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{CS} = \pm 25 \text{ V}$			±1	uA	
Zero Gate Voltage Drain Ourrent	<b>L</b>	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$			-1	uA	
Zero Gale Voltage Drain Guilerii.	l <sub>DSS</sub>	$V_{DS} = -24 \text{ V}, V_{CS} = 0 \text{ V}, T_J = 55^{\circ}\text{C}$			-5		
On-State Drain Current <sup>A</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	-50			Α	
Donin Course On DesigtanceA		$V_{GS} = -10 \text{ V}, I_D = -11.5 \text{ A}$			13	mΩ	
Drain-Source On-Resistance <sup>A</sup>	r <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -9.3 \text{ A}$			19.0	1162	
Forward Tranconductance <sup>A</sup>	9 <sub>fs</sub>	$V_{DS} = -15 \text{ V}, I_D = -11.5 \text{ A}$		29		S	
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> = 2.5 A, V <sub>GS</sub> = 0 V		-0.8		V	
Dynamic <sup>b</sup>							
Total Gate Charge	$Q_g$	\/ - 15\/\/ - 5\/		25			
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{CS} = -5 \text{ V},$ $I_{D} = -11.5 \text{ A}$		11		nC	
Gate-Drain Charge	Q <sub>gd</sub>	I <sub>D</sub> = -11.5 A		17			
Input Capacitance	Gss			2300			
Output Capacitance	Coss			600		рF	
Reverse Transfer Capacitance	C <sub>rss</sub>			300			
Tum-On Delay Time	t <sub>d(on)</sub>			15			
Rise Time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_L = 6 \Omega$ ,		13		nS	
Turn-Off Delay Time	t <sub>d(off)</sub>	ID=-1 A, VGEN=-10 V		100		'	
Fall-Time	t <sub>f</sub>			54			

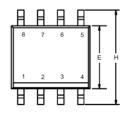
## Notes

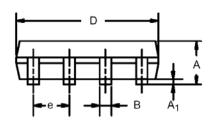
- a. Pulse test:  $PW \le 300us duty cycle \le 2\%$ .
- b. Guaranteed by design, not subject to production testing.

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## Package Information

SO-8: 8LEAD





	MILLIN	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	

